

Product / Process Change Notification



N° 2017-012-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an additional wafer test site IFX Kulim, Malaysia for IGBT driver products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **19. June 2017**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► **Products affected:**

Sales Name	SP N°	OPN	Package
1ED020I12-B2	SP000898878	1ED020I12B2XUMA1	PG-DSO-16
1ED020I12-BT	SP000920032	1ED020I12BTXUMA1	PG-DSO-16
1ED020I12-F	SP000922444	1ED020I12FXUMA2	PG-DSO-16
1ED020I12-F2	SP000920028	1ED020I12F2XUMA1	PG-DSO-16
1ED020I12FA	SP000922446	1ED020I12FAXUMA2	PG-DSO-20
1ED020I12FA	SP000922446	1ED020I12FAXUMA2	PG-DSO-20
1ED020I12FA2	SP001080574	1ED020I12FA2XUMA2	PG-DSO-20
1ED020I12-FF	SP001017558	1ED020I12FFXUMA1	PG-DSO-16
1ED020I12-FT	SP000920030	1ED020I12FTXUMA1	PG-DSO-16
1ED020I12FTA	SP001054670	1ED020I12FTAXUMA2	PG-DSO-20
2ED020I12-F2	SP000920036	2ED020I12F2XUMA1	PG-DSO-36
2ED020I12-F2	SP000920036	2ED020I12F2XUMA1	PG-DSO-36
2ED020I12FA	SP001054678	2ED020I12FAXUMA2	PG-DSO-36

► **Detailed Change Information:**

Subject: Introduction of an additional wafer test site IFX Kulim, Malaysia for IGBT driver products.

Reason: Increased high volume supply security by releasing a second site for wafer test.

Description:

Wafertest:

Old

Infineon Technologies Austria AG, Villach, Austria

New

Infineon Technologies Austria AG, Villach, Austria
or
Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia

► **Product Identification:**

Product identification done by SP number and OPN.

► **Impact of Change:**

No impact on electrical performance, no change in form, fit, function.

► **Attachments:**

N.A.

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► Time Schedule:

■ Final qualification report:	Available (AMSA)
■ First Samples available:	N.A.
■ Intended start of delivery:	01-November-2017

If you have any questions, please do not hesitate to contact your local Sales office.